

PRELIMINARY PRODUCT INFORMATION

**NEC**

**GaAs INTEGRATED CIRCUIT**  
**uPG2163T5N**

**GaAs MMIC SPDT SWITCH FOR 2.4 GHz AND 5 GHz DUALBAND WIRELESS LAN**

**DESCRIPTION**

The uPG2163T5N is a GaAs MMIC SPDT switch for 2.4 GHz and 5 GHz dualband wireless LAN. Low insertion loss and dual band operations suit to dualband wireless LAN system.

**FEATURES**

- Operating frequency : f = 2.4 to 2.5 GHz and 4.9 to 6.0 GHz
- Low insertion loss : L<sub>INS</sub> = 0.4 dB TYP. @ f = 2.4 to 2.5 GHz  
: L<sub>INS</sub> = 0.5 dB TYP. @ f = 4.9 to 6.0 GHz
- Handling power : P<sub>in</sub> (1 dB) = +31 dBm TYP. @ f = 2.5 GHz  
+29 dBm TYP. @ f = 6.0 GHz
- High isolation : ISL = 35 dB TYP. @ f = 2.4 to 2.5 GHz  
: ISL = 30 dB TYP. @ f = 4.9 to 6.0 GHz
- Input/output return loss : RL<sub>in</sub>/RL<sub>out</sub> = 15 dB TYP. @ f = 2.4 to 2.5 GHz  
: RL<sub>in</sub>/RL<sub>out</sub> = 15 dB TYP. @ f = 4.9 to 6.0 GHz
- 6-pin plastic TSON package (1.5 × 1.5 × 0.4 mm)

**APPLICATION**

- 2.4 GHz and 5 GHz dualband wireless LAN : IEEE802.11a+b/g

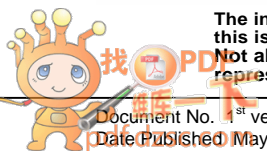
**ORDERING INFORMATION**

Part Number	Package	Marking	Supplying Form
uPG2163T5N-E2	6pinTSON	TBD	<ul style="list-style-type: none"> <li>• Embossed tape 8 mm wide</li> <li>• Pin 1.6 face to tape perforation side</li> <li>• Qty TBD kpcs/reel</li> </ul>

**Remark** To order evaluation samples, contact your nearby sales office.  
Part number for sample order: uPG2163T5N

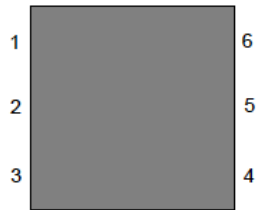
**Caution** Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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Not all devices/types available in every country. Please check with local NEC Compound Semiconductor Devices representative for availability and additional information.

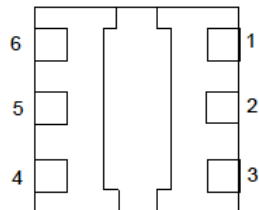


**PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM**

Top View



Bottom View



Pin No.	Pin Name
1	NC (GND)
2	Vcont2
3	RX
4	TX
5	Vcont1
6	ANT
EXPOSED PAD	GND

**Remark** NC is functionally non-connection pin but actually grounding is recommended.

**TRUTH TABLE**

V <sub>cont1</sub>	V <sub>cont2</sub>	ANT-RX	ANT-TX
High	Low	ON	OFF
Low	High	OFF	ON

**ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = +25°C, unless otherwise specified)**

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	V <sub>cont</sub>	-6.0 to +6.0 <sup>Note 1</sup>	V
Input Power	P <sub>in</sub>	TBD	dBm
Operating Ambient Temperature	T <sub>A</sub>	-45 to +85	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C

**Notes 1.** |V<sub>cont1</sub> - V<sub>cont2</sub>| ≤ 6.0 V

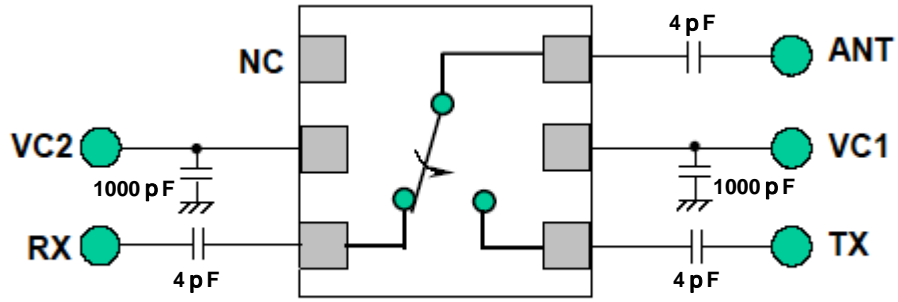
**RECOMMENDED OPERATING RANGE (T<sub>A</sub> = +25°C)**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency 1	f1	2.4	–	2.5	GHz
Operating Frequency 2	f2	4.9	–	6.0	GHz
Switch Control Voltage (H)	V <sub>cont (H)</sub>	2.7	3.0	5.0	V
Switch Control Voltage (L)	V <sub>cont (L)</sub>	–0.2	0	0.2	V

**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = +25°C, V<sub>cont</sub> = 3.0 V/0 V, Z<sub>o</sub> = 50 Ω, DC blocking capacitors value: 4 pF, Each port, unless otherwise specified)**

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	Lins	f = 2.4 to 2.5 GHz	–	0.4	TBD	dB
		f = 4.9 to 6.0 GHz	–	0.5	TBD	dB
Isolation	ISL	f = 2.4 to 2.5 GHz	TBD	35	–	dB
		f = 4.9 to 6.0 GHz	TBD	30	–	dB
Input Return Loss	RLin	f = 2.4 to 2.5 GHz	–	15	–	dB
		f = 4.9 to 6.0 GHz	–	15	–	dB
Output Return Loss	RLout	f = 2.4 to 2.5 GHz	–	15	–	dB
		f = 4.9 to 6.0 GHz	–	15	–	dB
1 dB Gain Compression Input Power	P <sub>in (1 dB)</sub>	f = 2.5 GHz	–	31	–	dBm
		f = 6.0 GHz	–	29	–	dBm
Switch Control Speed	t <sub>sw</sub>		–	50	–	ns
Control Current	I <sub>cont</sub>	RF Non	–	0.7	1.5	μ A

EVALUATION CIRCUIT

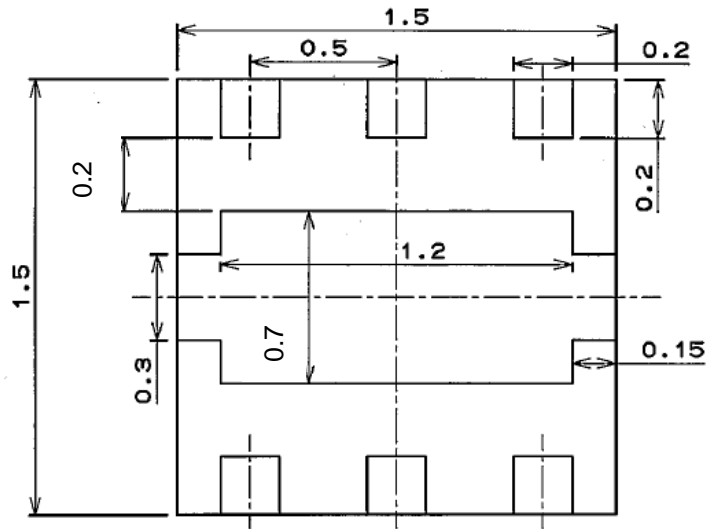


The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

PACKAGE DIMENSIONS

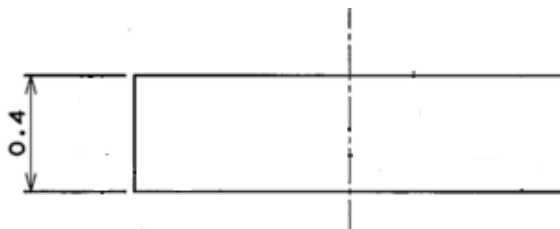
6-PIN PLASTIC TSON (UNIT: mm)

( Bottom View )



*Preliminary*

( Side View )



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M8E 00.4-0110

<div style="border: 1px solid black; padding: 2px; display: inline-block;"><b>Caution</b></div>	<p>GaAs Products</p>	<p>This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.</p> <ul style="list-style-type: none"> <li>• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.               <ol style="list-style-type: none"> <li>1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> <li>2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.</li> </ol> </li> <li>• Do not burn, destroy, cut, crush, or chemically dissolve the product.</li> <li>• Do not lick the product or in any way allow it to enter the mouth.</li> </ul>
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► **For further information, please contact**

**NEC Compound Semiconductor Devices, Ltd.**    <http://www.ncsd.necel.com/>  
 E-mail: salesinfo@ml.ncsd.necel.com (sales and general)  
           techinfo@ml.ncsd.necel.com (technical)  
 5th Sales Group, Sales Division    TEL: +81-44-435-1588    FAX: +81-44-435-1579

**NEC Compound Semiconductor Devices Hong Kong Limited**  
 E-mail: ncsd-hk@elhk.nec.com.hk (sales, technical and general)  
 Hong Kong Head Office    TEL: +852-3107-7303    FAX: +852-3107-7309  
 Taipei Branch Office        TEL: +886-2-8712-0478    FAX: +886-2-2545-3859  
 Korea Branch Office        TEL: +82-2-558-2120    FAX: +82-2-558-5209

**NEC Electronics (Europe) GmbH**    <http://www.ee.nec.de/>  
 TEL: +49-211-6503-0    FAX: +49-211-6503-1327

**California Eastern Laboratories, Inc.**    <http://www.cel.com/>  
 TEL: +1-408-988-3500    FAX: +1-408-988-0279